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**F-RAM vs. BBSRAM:** Functional and System Design Comparisons

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**Product Release**

**Low-Cost Enclosure Family Provides System-Level Solution with Advanced Thermal Management Options**

SPOKANE, Wash. -- (BUSINESS WIRE) -- Purcell Systems Inc. announced the launch of a new value-priced product family to round out its product line offering. EcoFlex™ is a NEMA 3R-rated modular enclosure system with a modular design for applications in telco, utility/energy, cable/MISO and government/military markets.

EcoFlex's key differentiators are linked to Purcell's long-established excellence in thermal management integration and packaging, to provide a complete system-level solution, coupled with industry-recognized excellence in quality and 365/24/7 Fanatical Service™ and support.

The enclosure line features advanced thermal management options including thermoelectric cooling and compartmentalized zone-cooling, in addition to traditional air conditioning, air-to-air heat exchangers and direct-air cooling.

EcoFlex also offers options for telco boxes, load centers, generator inlets and battery racks. With a footprint of 30 x 30 inches, the EcoFlex family of outdoor enclosures will be available in four sizes, including 17RU, 25RU, 33RU and 41 RU models, with corresponding overall heights of 33, 47, 61 and 75 inches, respectively.

Wireless Design & Development

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**Wireless Remote Control on a Chip**

Silicon Laboratories Inc. today introduced an EZRadio® wireless IC solution designed to reduce the cost and complexity of one-way wireless links used in a wide range of consumer, industrial and automotive systems.

**Wideband Attenuators Feature Excellent Linearity for Test Equipment Applications**

Hittite Microwave Corporation has introduced three new SMT packaged high linearity 1-bit digital attenuators which are ideal for automotive, broadband, cellular/3G, WiMAX/4G, military and test & measurement equipment applications from DC to 10 GHz.